

## Claims

1. A bisphenol compound composition having excellent thermal stability, characterized in that it comprises a pyridine compound in an amount of from 1 ppt to 10 ppm calculated as pyridine.

2. The bisphenol compound composition having excellent thermal stability according to claim 1, wherein the pyridine compound is a mercaptoalkylpyridine.

3. The bisphenol compound composition having excellent thermal stability according to claim 1 or 2, wherein it comprises a pyridine compound in an amount of 10 ppt or more calculated as pyridine.

4. The bisphenol compound composition having excellent thermal stability according to any one of claims 1 to 3, wherein it comprises a pyridine compound in an amount of 1 ppm or less calculated as pyridine.

5. A method for improving thermal stability of a bisphenol compound, characterized in that a pyridine compound is added to the bisphenol compound to a concentration of from 1 ppt to 10 ppm.